

NEGATIVE-WORKING PHOTORESIST COMPOSITIONS FOR LASER ABLATION AND USE THEREOF

Disclosed are novel compositions whose films coated on a substrate are both phenolic negative tone crosslinking resist sensitive to broadband UV radiation and in areas exposed to this broadband radiation also are patternable by cold laser ablation with an Excimer laser emitting at a wavelength between 222 nm and 308 nm and also capable of being coated as thick films.

Also disclosed are novel methods of making relief images by imaging films coated from this composition through cold laser ablation with an excimer laser emitting at a wavelength between 222 nm and 308 nm a film of these novel composition coated on a substrate that have been previously been cross-linked by broadband exposure.

Also further disclosed is another novel method of making images with the novel composition which is to cold laser ablate with an excimer laser emitting at a wavelength between 222 nm and 308 nm a topographical image previously imaged into a film of the novel composition on a substrate by exposure with a Broadband UV exposure through a mask and development with an aqueous base.

The relief images prepared from these novel compositions and methods can be used in the formation of metal bumps and posts useful for electronic innerlayer interconnections. They can also be used as templates for electrochemical deposition of metal wiring patterns. These photofabrication methods have found utility in such application as chip scale packaging, microelectronic machine systems, high density interconnections, liquid crystal devices, organic transistors, light emitting diode, displays and the like.

The manufacture of many electronic components can often only easily be achieved with the use of thick film photosensitive photoresist materials, compositions and methods. The process involves coating a desired substrate with a photosensitive photoresist composition and drying followed by exposing the photoresist to actinic radiation through a photomask which contains the desired pattern of line traces, bump holes and other structures. In the case of a negative photoresist the exposed areas are hardened, while when exposing

through a mask the unexposed areas are removed by a suitable developing solution, generally aqueous based. In many photofabrication processes the thickness of the coated and dried photoresist is required to be 30 μm (microns) while the line traces, bump holes and other structures have dimension that can be at least 15 μm (microns). Once the line traces, bumps and other structures are fabricated the photoresist is removed in a stripping process again typically using aqueously based solutions.

EP 1193557 discloses a composition comprising an alkaline soluble resin containing phenolic group moieties, carboxylic acid moieties or a combination of both types moieties, a cross-linker being e.g. hexamethoximethylol melamine, a photo initiator sensitive to broadband radiation and a trihalomethyl triazine. The resin composition for the formation of cathode separators and electroluminescent display devices.

Cold laser ablation is achieved when the laser excitation results in direct bond scission. Specifically, this is a photochemical process in which the temperature of the system is unchanged. This is typically done with a UV Excimer Laser emitting between 222 nm and 308 nm.

The Inventive formulations of this application are comprised of a negative tone resist which when coated on a substrate are sensitive to broadband UV radiation whose imaging at this wavelength operates through a crosslinking reaction induced by broadband radiation, but which are also sensitivity to cold laser ablation with a UV Excimer laser emitting between 222 nm and 308 nm.

These novel composition contain the following:

- 1) components which allow the composition to be coated as a thick film on a substrate and impart to these coatings on a substrate the property of being a negative tone, crosslinking, base developable resist coating sensitive to broadband radiation and

- 2) at least one additional sensitizer component which after broadband exposed film coated and exposed to broadband radiation sensitivity to cold laser ablation.

The components for imparting negative tone broadband sensitivity a base soluble resin comprised of phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base, an organic solvent which can dissolve all components of the novel composition and make the composition suitable for coating thick film on a substrate; at least one crosslinker; at least one photoinitiator sensitive to broadband irradiation.

The additive which sensitizes the coating composition to cold laser ablation with an Excimer laser between 222 nm and 308 nm is comprised of a conjugated aryl compound absorbing ultraviolet radiation strongly from 222 nm to to 310 nm.

In these novel composition the cross-linker is induced by broadband irradiation to undergo a crosslinking reaction in the coated film of the phenolic composition. This crosslinking induced by broadband irradiation occurs through a mechanism where the phenolic resin and the crosslinker are induced to undergo crosslinking by radical, cation, acid or a combination of these moieties generated a photoinitiator system sensitive to broadband UV irradiation.

The broadband photoinitiator system in this composition is comprised of a photoacid generator additive, photoradical generator additive or a combination of both type of photoinitiators. These photoinitiators may be inherently sensitive to broadband irradiation or alternatively are sensitized to broadband irradiation by an appropriate broadband sensitizer additive.

Areas of the composition coated on a substrate, not exposed to broadband radiation maintain solubility in aqueous base while areas exposed are crosslinked generating a negative tone image upon aqueous base development.

Because this novel composition is also comprised of laser ablation additives the coated films of this material, after broadband UV exposed films are very susceptible cold laser ablation with an Excimer laser emitting UV radiation between 222 nm and 308 nm producing.

This invention also pertains for the novel use of such novel coating formulations in two imaging approaches.

In the first approach, a cross-linked film is produced by blanket flood exposure with broadband radiation of a film of the novel composition cast on a substrate; images are then produced by ablation with the Excimer laser in select areas of the cross-linked film.

In the second imaging approach, an image produced by conventional exposure of the of a film of the novel composition cast on a substrate to broadband radiation through a mask followed by aqueous base development and removal of the non-exposed area to produce a first topographical image; however, this first topographical images may subsequently be modified by cold Excimer laser ablation ablating away selected topographical areas of first image.

In both kinds of processes, features such as deep contact holes, vias and other topographical features are formed by cold laser ablation that are be produced having stepper profiles, smoother sidewalls with fewer Excimer laser pulse than conventional laser ablation formulations.

Excimer Cold Laser ablation of conventional non-imageable, non-crosslinking polymeric resins has several drawbacks as follows:

Simple Polymer are susceptible to thermal flow unless a cure step is added and the formulation is made to be thermally curable. Also, the polymer needs to also be designed with a chemical resistance to the etching processes subsequently employed for pattern transfer to the substrate in the manufacture of MEM's Sensors and other microelectronic components. Moreover, such polymers may not be soluble in environmentally friendly spin casting solvents.

Negative broadband resists suitable as component in our novel laser ablation composition must have several properties which make them suitable for use as a component in our novel cold laser ablation formulations as follows.

- 1) They must be imageable with broadband exposure.

2) Developable in aqueous base.

3) Imaged upon broadband exposure through the action of at least one crosslinking additive which crosslinkable through the action of an acid, a radical or both

4) Contain a photoacid generator, photoradical generator which is inherently sensitive to broadband or is sensitive to broadband when combined with a broadband sensitizer.

5) Formulated in an environmentally safe spin casting solvent

The other component in our novel composition are additives which impart sensitivity to cold laser ablation with an Excimer laser emitting UV radiation between 222 nm and 308 nm. These additives must impart to the above described negative resist a high ablation rate with these Excimer lasers. They must also be soluble in the environmentally safe spin casting solvent.

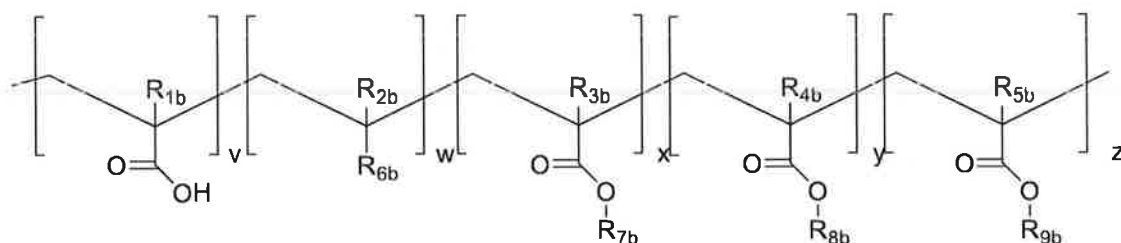
The novel compositions and processes of this invention solve the problem of forming precise features in thick films 5-100 μm through cold laser ablation where the features have high aspect ratios and also have high wall angles, and low sidewall roughness and at the same time have a high ablation rate with an Excimer laser emitting at a wavelength between 222 nm and 308 nm. The ability to make such features is useful in the manufacturing of MEMS, sensors and other microelectronic components.

SUMMARY OF THE INVENTION

The present invention provides a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive to in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm as claimed in claim 1 where the composition is comprised of components of type a) and b);

a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of

a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C_2 - C_{10} hydroxy alkyl group; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 25 - 40$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

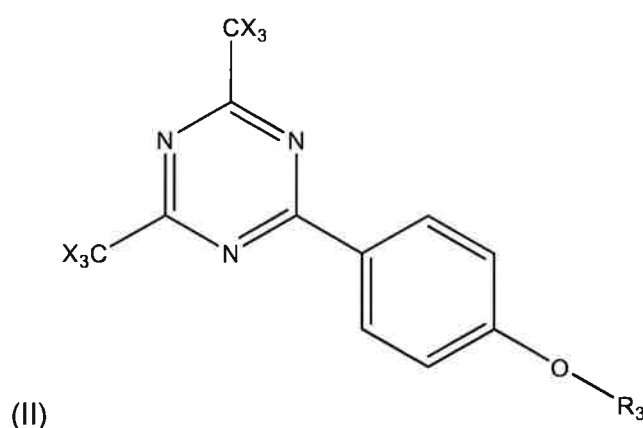
b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and

d-2) a photoresist solvent,

and

b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



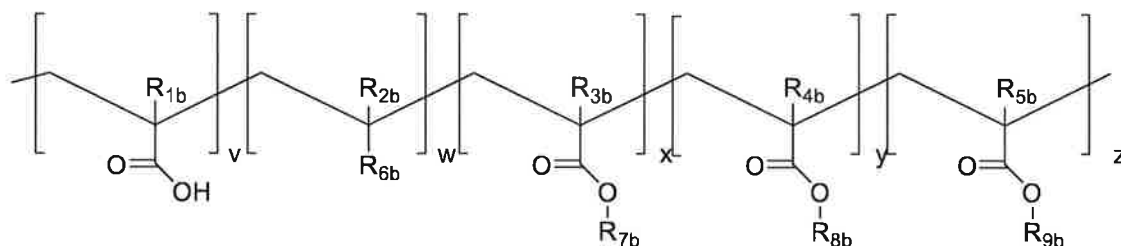
where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylenefluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I. Embodiments thereof are described in dependent claims 2-7.

The present invention also encompasses a process for making relief images, as claimed in claim 8, comprising steps a), b) and c)

a) coating a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);

a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of

a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl

group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched $C_2 - C_{10}$ hydroxy alkyl group and a $C_2 - C_{10}$ hydroxy alkyl acrylate; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 0 - 45$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

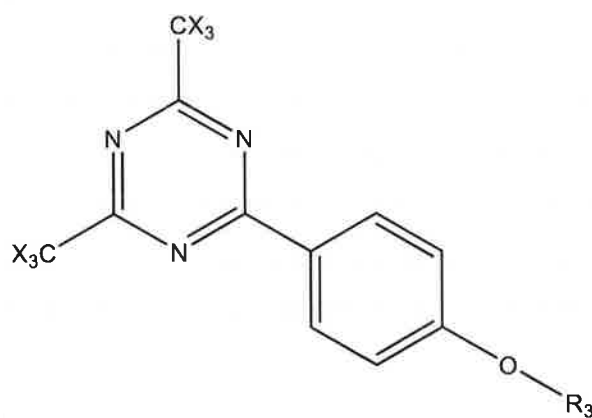
b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and

d-2) a photoresist solvent,

and

b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylene fluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I, on a substrate;

b) cross-linking the entire coating by blanket irradiation with broadband UV exposure; and

- c) forming a pattern in the cross-linked coating by cold laser ablating with a UV excimer laser emitting between 222 nm and 308 nm.

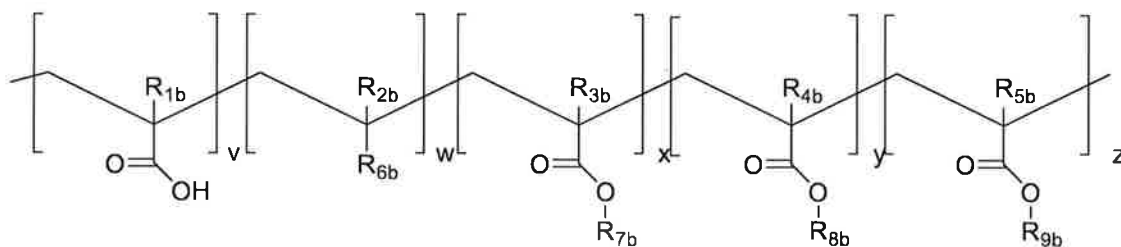
Embodiments thereof are described in dependent claims 9-11.

The present invention further provides process for making relief images as claimed in claim 12, comprising steps a), b), c) and d)

- a) coating a coating a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);

- a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of

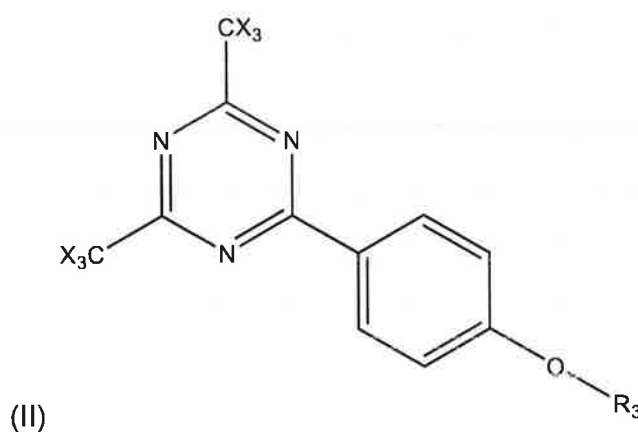
- a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C_2 - C_{10} hydroxy alkyl group and a C_2 - C_{10} hydroxy alkyl acrylate; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 0 - 45$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

- b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

- c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and
- d-2) a photoresist solvent, and
- b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylene fluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I, on a substrate;

- b) cross-linking part of the coating by irradiation with broadband UV exposure through a mask;
- c) developing the coating with aqueous base removing the unexposed areas of the coating, thereby forming a first pattern;
- d) forming a second pattern in the first pattern by cold laser ablating of the first pattern with a UV excimer laser emitting between 222 nm and 308 nm.

An embodiment thereof is described in dependent claim 13.

DETAILED DESCRIPTION OF DRAWINGS

Figures 1 Comparative Study Top Down SEM Pictures: Comparative Formulation Example 1: and Formulation Example 1.

DETAILED DESCRIPTION

Throughout the present specification, unless otherwise stated the terms used are described below.

As used herein, the conjunction “and” is intended to be inclusive and the conjunction “or” is not intended to be exclusive unless otherwise indicated. For example, the phrase “or, alternatively” is intended to be exclusive.

As used herein the terms “photocure” and “photopolymerize” are used interchangeably and refer to free radical initiated curing or polymerization.

As used herein the term “dried” refers to films with less than 5% solvent remaining after the drying process.

As used herein the term “thick film” refer to films which are between 5 - 100 μm (microns) thick.

As used herein the term “phenolic” refers to an aryl moiety on which at least one hydroxyl group is present attached to an aromatic ring.

In the above definitions and throughout the present specification, unless otherwise stated the terms used are described below.

Alkyl means linear or branched alkyl having the desirable number of carbon atoms and valence. The alkyl group is generally aliphatic and may be cyclic or acyclic (i.e. noncyclic). Suitable acyclic groups can be methyl, ethyl, n-or iso-propyl, n-,iso, or tert-butyl, linear or branched pentyl, hexyl, heptyl, octyl, decyl, dodecyl, tetradecyl and hexadecyl. Unless otherwise stated, alkyl refers to 1-10 carbon atom moiety. The cyclic alkyl groups may be mono cyclic or polycyclic. Suitable example of mono-cyclic alkyl groups include substituted cyclopentyl, cyclohexyl, and cycloheptyl groups. The substituents may be any of the acyclic alkyl groups described herein.

Suitable bicyclic alkyl groups include substituted bicyclo[2.2.1]heptane, bicyclo[2.2.2]octane, bicyclo[3.2.1]octane, bicyclo[3.2.2]nonane, and

bicyclo[3.3.2]decane, and the like. Examples of tricyclic alkyl groups include tricyclo[5.4.0.0.^{2,9}]undecane, tricyclo[4.2.1.2.^{7,9}]undecane, tricyclo[5.3.2.0.^{4,9}]dodecane, and tricyclo[5.2.1.0.^{2,6}]decane. As mentioned herein the cyclic alkyl groups may have any of the acyclic alkyl groups as substituents.

Alkylene groups are divalent alkyl groups derived from any of the alkyl groups mentioned hereinabove. When referring to alkylene groups, these include an alkylene chain substituted with (C₁-C₆)alkyl groups in the main carbon chain of the alkylene group. Alkylene groups can also include one or more alkyne groups in the alkylene moiety, where alkyne refers to a triple bond. Essentially an alkylene is a divalent hydrocarbon group as the backbone. Accordingly, a divalent acyclic group may be methylene, 1,1- or 1,2-ethylene, 1,1-, 1,2-, or 1,3 propylene, 2,5-dimethyl-2,5-hexene, 2,5-dimethyl-2,5-hex-3-yne, and so on. Similarly, a divalent cyclic alkyl group may be 1,2- or 1,3-cyclopentylene, 1,2-, 1,3-, or 1,4-cyclohexylene, and the like. A divalent tricyclo alkyl groups may be any of the tricyclic alkyl groups mentioned herein above. A particularly useful tricyclic alkyl group in this invention is 4,8-bis(methylene)-tricyclo[5.2.1.0.^{2,6}]decane.

Aryl groups contain 6 to 24 carbon atoms including phenyl, tolyl, xylyl, naphthyl, anthracyl, biphenyls, bis-phenyls, tris-phenyls and the like. These aryl groups may further be substituted with any of the appropriate substituents e.g. alkyl, alkoxy, acyl or aryl groups mentioned hereinabove. Similarly, appropriate polyvalent aryl groups as desired may be used in this invention. Representative examples of divalent aryl groups include phenylenes, xylylenes, naphthylenes, biphenylenes, and the like.

Alkoxy means straight or branched chain alkoxy having 1 to 10 carbon atoms, and includes, for example, methoxy, ethoxy, n-propoxy, isopropoxy, n-butoxy, isobutoxy, tert-butoxy, pentyloxy, hexyloxy, heptyloxy, octyloxy, nonanyloxy, decanyloxy, 4-methylhexyloxy, 2-propylheptyloxy, and 2-ethyloctyloxy.

Aralkyl means aryl groups with attached substituents. The substituents may be any such as alkyl, alkoxy, acyl, etc. Examples of monovalent aralkyl

having 7 to 24 carbon atoms include phenylmethyl, phenylethyl, diphenylmethyl, 1,1- or 1,2-diphenylethyl, 1,1-, 1,2-, 2,2-, or 1,3-diphenylpropyl, and the like. Appropriate combinations of substituted aralkyl groups as described herein having desirable valence may be used as a polyvalent aralkyl group.

The term (meth)acrylate refers to methacrylate or acrylate, and similarly, (meth)acrylic refers to methacrylic or acrylic.

The term acid cleavable group refers to a protecting group masking a alcohol, phenol, or carboxylic acid functionality which can be cleaved through a acid initiated catalytic process such as acidolysis where or hydrolysis where the chain length of the catalytic process entails a some juncture a sufficiently stable carbocation intermediate to sustain a long catalytic chain. Examples of such moieties are the following:

tertiary, secondary benzylic, secondary allylic, (or other activated secondary carbocations containing a substituent stabilizing the carbocation) which contain at least one proton on a carbon atom adjacent capable of being abstracted to regenerate the acid;

carbocation to which two oxygen atoms are attached to the carbon containing the positive charge, such as are formed in the hydrolysis of acetals and ketals;

silyl cations on which are attached three carbon atoms as are formed in the hydrolysis of moieties such as trialkylsilyl ethers or esters triarylsilyl ethers or ester, and diarylalkylsilyl ethers or esters and the like. The term acid cleavable bond refers to the bond undergoing acid catalyzed cleavage in the above acid cleavable groups and the like.

Such acid cleavable groups are generally used in chemically amplified resist processes where the acid originates from a photo-acid generator (PAG) and the catalytic process amplifies the quantum yield for photo-generation of acid. These groups may also be cleaved by acid originating thermally from a thermal acid generator (TAG). Materials which undergo ineffective hydrolysis such as materials that undergo hydrolysis through a primary carbocations, or unactivated secondary carbocations are not considered as acid cleavable

group nor are materials that undergo ineffective hydrolysis through a tertiary or secondary carbocation because they do not have an abstractable hydrogen to reform the acid in an acidolysis process as described above.

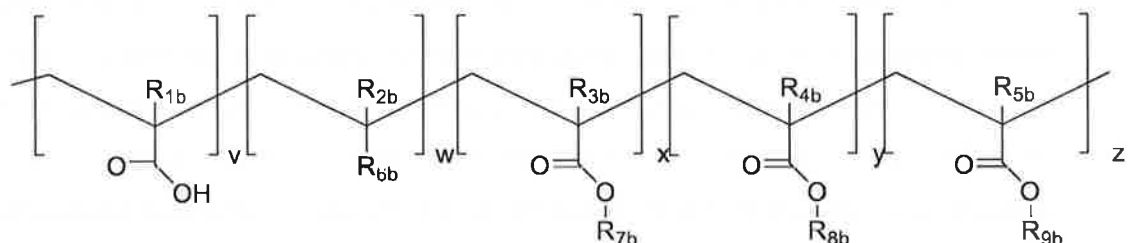
Furthermore, and as used herein, the term "substituted" is contemplated to include all permissible substituents of organic compounds. In a broad aspect, the permissible substituents include acyclic and cyclic, branched and unbranched, carbocyclic and heterocyclic, aromatic and non-aromatic substituents of organic compounds. Illustrative substituents include, for example, those described hereinabove. The permissible substituents can be one or more and the same or different for appropriate organic compounds. For purposes of this invention, the heteroatoms such as nitrogen may have hydrogen substituents and/or any permissible substituents of organic compounds described herein which satisfy the valencies of the heteroatoms. This invention is not intended to be limited in any manner by the permissible substituents of organic compounds.

COMPOSITIONS

One aspect of this invention is a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive to in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);

a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of

a-2) at least one polymer comprising a structure of the following formula:



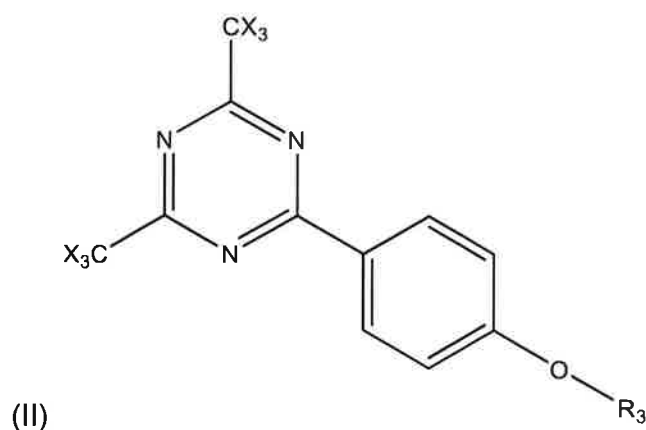
wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C_2 - C_{10} hydroxy alkyl group; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 25 - 40$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and

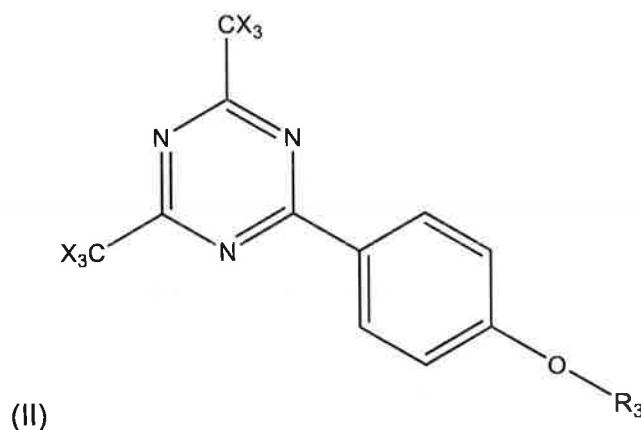
d-2) a photoresist solvent,
and

b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylfluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I.

The conjugated aryl additive in b) absorbing strongly from 222 nm to 310 nm is chosen from;



where each is independently chosen from hydrogen, an alkyl group, a alkylenefluoroalkyl group, an alkylene aryl group, and a alkyleneoxyalkyl group.

In another aspect of this invention the a) components imparting negative tone aqueous base developability upon broadband irradiation may be selected from composition imparting broadband UV sensitivity as described in the following patent documents US89065095, US7601482 and US6576394.

In this aspect of this invention the a) components imparting negative tone aqueous bases developability upon broadband irradiation may be selected from the a) the components for imparting negative tone aqueous base developable, broadband UV resist behavior are selected from the component group (X).

Group (X)

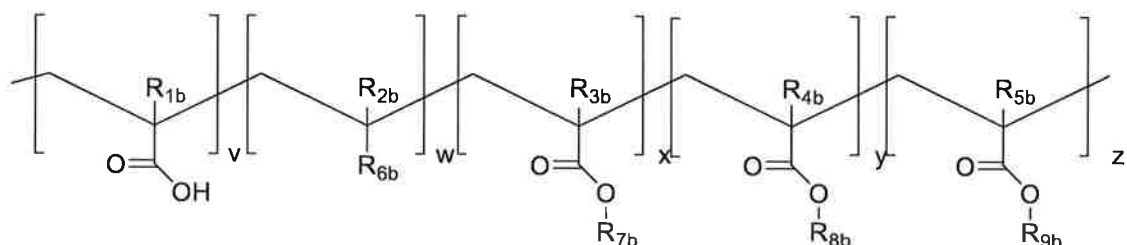
In one embodiment of the type (X) component needed for imparting broadband negative tone resist behavior in the novel compositions capable of cold Excimer laser ablation of this invention, this component is comprised of the following:

In another embodiment of the type (X) component needed for imparting broadband negative tone resist behavior in the novel compositions capable of

cold Excimer laser ablation of this invention, this component is comprised of components a-2 to d-2 wherein

a-2 is at least one polymer comprising a structure of the following formula

(Xa):



(Xa)

wherein R_{1b} - R_{5b} is independently H, F or CH_3 , R_6 is selected from a group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl group and unsubstituted heteroaryl group, R_{7b} is a substituted or unsubstituted benzyl group, R_{8b} is a linear or branched C_2 - C_{10} hydroxy alkyl group or a C_2 - C_{10} hydroxy alkyl acrylate and R_9 is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 0 - 45$ mole%.

b-2) one or more free radical initiators activated by broadband radiation,

c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1, and

d-2) a solvent.

In another embodiment of the above embodiments the type X composition is capable of being solubilized in aqueous alkaline developer prior to crosslinking the acrylate monomers.

In another embodiment of the above embodiments the type X compositions of the above embodiments further comprising at least one polymer comprising the reaction product of styrene and at least one acid

containing monomer or maleic anhydride, said anhydride reaction product being further partially esterified with an alcohol.

In another embodiment of the above embodiments the type X compositions of the above embodiments further comprising one or more crosslinkable acrylated siloxane or acrylated silsesquioxane based monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1.

a-2) Other embodiments of polymer comprising a structure of formula (Xa)

In one embodiment of the composition of type (X) the polymer comprising a structure (Xa) is one in which R_{1b} through R_{5b} are independently a methyl group, hydrogen or fluoride. R_{1b} through R_{5b} may be the same or different depending on the desired properties of the polymer. One of the components of the polymer contains a carboxylic acid prepared from the appropriate acrylic acid monomer, wherein R_{1b} is methyl, a hydrogen atom, or a fluoride atom. R_{6b} is a substituted or unsubstituted aryl group, such as, for example, phenyl, tolyl, xylyl, naphthyl, anthracyl, biphenyl, triphenyl and the like substituted with $C_1 - C_{24}$ alkyl or alkenyl groups or other functional group as well as 5, 6 and 7 ring heterocyclic aromatic groups such as azoles, thiazoles, oxazoles, pyridine, pyridazine, and the like. R_{7b} is a substituted or unsubstituted benzyl group which may be substituted with, for example, $C_1 - C_{24}$ alkyl or alkenyl groups or other functional groups. R_{8b} is a linear or branched, $C_2 - C_{10}$ hydroxy alkyl group or a $C_2 - C_{10}$ hydroxy alkyl acrylate such as for example, wherein the hydroxy group is attached to the second carbon in the chain such as, $-CH_2-CH_2-OH$, $-CH_2-CH(OH)-CH_3$, or $-CH_2-CH(OH)-CH_2-CH_3$ as well as wherein the hydroxy group is attached to the third carbon in the chain or other carbon. The hydroxy alkyl acrylate may be and methacrylated glycerol acrylate, $-CH_2-CH(OH)-CH_2OC(O)C(=CH_2)CH_3$.

In another embodiment the polymer comprising a structure (Xa) may further comprise other co-monomeric units, such as ones derived from cyclopentadienyl acrylate and campholyl acrylate. These additional co-

monomeric units may be present at 0-30 mole%.

Non limiting example of the acid labile group R_{9b} are for example, a t-butyl group, a tetrahydropyran-2-yl group, a tetrahydrofuran-2-yl group, a 4-methoxytetrahydropyran-4-yl group, a 1-ethoxyethyl group, a 1-butoxyethyl group, a 1-propoxyethyl group, a 3-oxocyclohexyl group, a 2-methyl-2-adamantyl group, a 2-ethyl-2-adamantyl group, a 8-methyl-8-tricyclo[5.2.1.0^{2,6}]decyl group, a 1,2,7,7-tetramethyl-2-norbornyl group, a 2-acetoxymethyl group, a 2-hydroxymethyl group a 1-methyl-1-cyclohexylethyl group, a 4-methyl-2-oxotetrahydro-2H-pyran-4-yl group, a 2,3-dimethylbutan-2-yl group, a 2,3,3-trimethylbutan-2-yl group, a 1-methyl cyclopentyl group, a 1-ethyl cyclopentyl group, a 1-methyl cyclohexyl group, 1-ethyl cyclohexyl group, a 1,2,3,3-tetramethylbicyclo[2.2.1]heptan-2-yl group, a 2-ethyl-1,3,3-trimethylbicyclo[2.2.1]heptan-2-yl group, a 2,6,6-trimethylbicyclo[3.1.1]heptan-2-yl group, a 2,3-dimethylpentan-3-yl group, or a 3-ethyl-2-methylpentan-3-yl group or other group that is cleaved when exposed to acid leaving behind a carboxylic acid group.

In one embodiment of this invention v in structure (Xa) is between 10 and 40 mole%, w is between 0 and 35 mole%, x is between 0 - 60 mole%, y is between 10 - 60 mole% and z is between 0 - 45 mole%. The general formula (Xa) above is not meant to show the exact positioning of the component parts of the polymer so that the parts may exist together randomly, as well, 2 or more of the same component part may exist side-by-side in the polymer.

In accordance with the above embodiments, with reference to (Xa), an exemplary molar percentage range for v may be 10-30 mole%. A further exemplary molar percentage range for v may be 15-25 mole%. An exemplary molar percentage range for w may be 0-25 mole%. A further exemplary molar percentage range for w may be 0-20 mole%. An exemplary molar percentage range for x may be 0-50 mole%. A further exemplary molar percentage range for x, when present, may be 30-55 mole%. An exemplary molar percentage range for y may be 20-45 mole%. A further exemplary molar percentage range for y may be 25-40 mole%. An exemplary molar percentage range for z may be 0-35 mole %. A further exemplary molar percentage range for z, when

present, may be 25-40 mole %. Mole percentages are not independent in that they must add to 100%.

a-2a) Other polymer components

The compositions may also include one or more polymers whose carboxylic acid prepared from the appropriate acrylic acid monomer, wherein R_{1b} is methyl, a hydrogen atom, or a fluoride atom, is replaced by a succinic acid half ester prepared by polymerizing maleic anhydride with other selected monomers to create a polymer and then reaction of the anhydride with an alcohol to create a carboxylic acid and an ester.

The polymers of the composition of the present composition can be prepared by any of the known methods for preparing polyacrylates.

b-2) Free radical initiators activated by broadband radiation

Component X may further contain one or more free radical initiators or initiator systems activated by broadband radiation. A single photoinitiator or a photoinitiator system containing multiple components may be used. The photoinitiator can be of a specific type, such as a halogenated-2,5cyclohexadienone, benzophenone, alkylaryl ketone or diketone type, or mixtures thereof. Any of a variety of free radical generating photoinitiators can be used in the current invention. Benzophenone derivatives such as benzophenone, bis-4,4'-dimethylaminobenzophenone (Michler's ketone), bis-4,4'-diethylaminobenzophenone (ethyl Michler's ketone), benzophenones singly or multiply substituted with other alkylamino groups, chloro, methoxy, etc. are suitable. Also substituted xanthenes, thioxanthenes, anthrones, and fluorenones are useful initiators, as well as alkyl, chloro, and alkoxy substituted thioxanthenes. Substituted cyclohexadienones can be also be used, such as with both an alkyl and a trichloromethyl substituent in the 4 position. Useful alkylarylketone derivatives include ketaldonyl alcohols such as benzoin, pivaloin, and acyloin ethers such as benzoin alkyl ethers, benzoin aryl ethers, alphasubstituted aromatic acyloins, benzoin dialkyl ketals, benzil, benzoin esters, O-acylated oximinoketones, and alpha-amino ketones such as alpha-aminoacetophenone derivatives. Substituted or unsubstituted polynuclear quinones such as 9,10-anthroquinones, 1,4-

naphthquinones, and phenanthrene quinones are also possible initiators. Tertiary amines suitable as electron and/or hydrogen donors can also be used as part of the initiating system such as substituted N,N-dialkylaminobenzene derivatives and ethyl 4-(dimethylamino)benzoate. Useful diketones include biacetyl, 2,3-dibenzoyl-2-norbornene, benzoylbenzal chloride, 2,2-dibromo-2(phenylsulfonyl)propanedione, alpha-naphthyl, 2,3-bornanedione, phenylpyruvic acid and 2,4-pentanedione. Representative quinones that can be used include 4-benzoquinone, 2-benzo-quinonediazide, anthraquinone, 2-methylantraquinone, 2,6-dimethoxyanthraquinone, 2,4,8-trichloroanthraquinone, amino anthraquinone, 1,4-naphthoquinone derivatives and phenanthrenequinones. Also useful as photoinitiators are 2,4,5-triphenylimidazolyl dimers in combination with chain transfer agents, or hydrogen donors.

c-2) Crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1

Component X may further contain one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking, wherein the acrylate functionality is greater than 1. Suitable monomers include 1,4-butanediol diacrylate, 1,5-pentanedioldiacrylate, diethylene glycol diacrylate, hexamethylene glycol diacrylate, 1,3-propanediol diacrylate, decamethylene glycol diacrylate, decamethylene glycol dimethacrylate, 1,4-cyclohexanediol diacrylate, 2,2-dimethylolpropane diacrylate, glycerol diacrylate, glycerol triacrylate, trimethylolpropane triacrylate, pentaerythritol triacrylate, polyoxyethylated trimethylolpropane tri(meth)acrylate, polypropoxylated trimethylolpropane tri(meth)acrylate and similar compounds, 2,2-di(p-hydroxyphenyl)propane diacrylate, pentaerythritol tetraacrylate, 2,2-di(p-hydroxyphenyl)propane dimethacrylate, triethylene glycol diacrylate, polyoxyethyl-2,2-di(p-hydroxyphenyl)propane dimethacrylate, bisphenol A diacrylate, di-(3-methacryloxy-2-hydroxypropyl)ether of bisphenol A, di-2-methacryloxyethyl ether of bisphenol A, di-(3-acryloxy-2-hydroxypropyl)ether of bisphenol A, di-2-acryloxyethyl ether of bisphenol A, di-(3-methacryloxy-2-

hydroxypropyl)ether of tetrachloro-bisphenol A, di-2methacryloxyethyl ether of tetrachloro-bisphenol A, di-(3methacryloxy- 2-hydroxypropyl)ether of tetrabromobisphenol A, di-2-methacryloxyethyl ether of tetrabromobisphenol A, di-(3-methacryloxy-2-hydroxypropyl)ether of 1,4-butanediol, triethylene glycol dimethacrylate, trimethylolpropane trimethacrylate, ethylene glycol dimethacrylate, butylene glycol dimethacrylate, 1,3-propanediol dimethacrylate, 1,2,4-butanetriol trimethacrylate, 2,2,4-trimethyl- 1,3-pentanediol dimethacrylate, 1,2,4-butanetriol trimethacrylate, 2,2,4- trimethyl- 1,3-pentanediol 1,5 dimethacrylate, pentaerythritol trimethacrylate, 1-phenylethylene- 1,2-dimethacrylate, pentaerythritol tetramethacrylate, 1,5-pentanediol dimethacrylate, 1,4-benzenediol dimethacrylate, 1,3,5-triisopropenyl benzene and polycaprolactone diacrylate.

d-2) a solvent

Solvents useful in embodiments of the inventive laser ablation composition containing component X are selected from the group consisting of C₁ -C₄ alcohols, C₄ -C₈ ethers, C₃ -C₆ ketones, C₃ -C₆ esters, and mixtures thereof. Examples of C₁ -C₄ alcohols include methanol, ethanol, 1-propanol, and 2-propanol. Examples of C₄ -C₈ ethers include diethyl ether, dipropyl ether, dibutyl ether and tetrahydrofuran. Examples of C₃ -C₆ ketones include acetone, methyl ethyl ketone and cyclohexanone. Examples of C₃ -C₆ esters include methyl acetate, ethyl acetate and n-butyl acetate.

Examples of suitable organic solvents for include ketones such as acetone, methyl ethyl ketone, cyclohexanone, methyl isoamyl ketone, methyl amyl ketone, and the like, polyhydric alcohols and derivatives thereof such as monomethyl, monoethyl, monopropyl, monobutyl and monophenyl ethers of ethyleneglycol, ethyleneglycol monoacetate, diethyleneglycol, diethyleneglycol monoacetate, propyleneglycol, propyleneglycol monoacetate, dipropyleneglycol or dipropyleneglycol monoacetate and the like, cyclic ethers such as dioxane, tetrahydrofuran and the like, esters such as methyl lactate, ethyl lactate, methyl acetate, ethyl acetate, butyl acetate and the like and solvents having aromatic groups such as anisole, ethyl benzene, xylenes, chlorobenzene, toluene and the like. Examples are propyleneglycol

monomethyl ether acetate, propyleneglycol monomethyl ether and ethyl lactate.

Solvents having one or more polar functional groups such as hydroxyl, ether, amide, ester, ketone, and carbonate, for example, two functional groups, which may be the same or different, such as two hydroxyl groups or one hydroxyl group and one ether group, including, for example, polyol, glycol ether, diacetone alcohol, 2-pyrrolidinone, N-methylpyrrolidinone, ethyl lactate, propylene carbonate, 1,3-dimethyl-2-imidazolidindione, and alkyl esters, and any combination thereof can be used.

For example, polyols such as polyethylene glycol, polypropylene glycol, poly(ethylene-co-propylene glycol), polyvinyl alcohol, trimethylol propane, ethylene glycol, glycerin, diethylene glycol, triethylene glycol, tripropylene glycol, tetraethylene glycol, pentaethylene glycol, 1,2-propylene glycol, 1,3-propanediol, butylene glycol, triethylene glycol, 1,2,6-hexanetriol, thiodiglycol, hexylene glycol, bis-2-hydroxyethyl ether, 1,4-butanediol, 1,2-butanediol, 1,4-butanediol, 1,3-butanediol, 1,5-pentanediol, 2,4-pentanediol, 2,4-heptanediol, 1,8-octanediol, 1,10-decanediol, 1,12-dodecanediol, 1,4-cyclohexanediol, 1,4-cyclohexanedimethanol, 1,2-bis(hydroxymethyl)cyclohexane, 1,2-bis(hydroxyethyl)-cyclohexane, 3-methyl-1,5-pentanediol, 2,2,4-trimethyl-1,3-pentanediol, neopentyl glycol, pentaerythritol, sorbitol, mannitol, and any combination thereof, including polyethylene glycol, trimethylol propane, ethylene glycol, glycerin, diethylene glycol, tripropylene glycol, and any combination thereof, can be used.

For example, glycol ethers such as ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, propylene glycol monomethyl ether, tripropylene glycol monomethyl ether, ethylene glycol monobutyl ether, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, propylene glycol n-propyl ether, propylene glycol t-butyl ether, propylene glycol n-butyl ether, dipropylene glycol methyl ether, dipropylene glycol n-propyl ether, dipropylene glycol t-butyl ether, dipropylene glycol n-butyl ether, tripropylene glycol n-propyl ether, tripropylene glycol t-butyl ether, tripropylene glycol n-butyl ether, ethyl cellosolve, methyl cellosolve, polyethylene glycol

monomethyl ether, polypropylene glycol monomethyl ether, methoxytriglycol, ethoxytriglycol, butoxytriglycol, 1-butoxyethoxy-2-propanol, and any combination thereof, including ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, propylene glycol monomethyl ether, tripropylene glycol monomethyl ether, ethylene glycol monobutyl ether, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, and any combination thereof, can be used.

These organic solvents can be used either singly or in admixture according to need.

The novel laser ablation composition comprised of components VIII, VIV or X when coated as a film on a substrate are either inherently soluble in aqueous base developer prior to exposure to broadband radiation or become soluble in unexposed area after a baking step due to cleavage of acid labile protecting groups during a baking step induced by acid originating from a thermal acid generator. In either case, upon exposure to broadband radiation exposed areas of the film become insoluble in aqueous base due to crosslinking. Typical aqueous alkaline developers including hydroxides, for example tetra (C₁-C₄ alkyl)ammonium hydroxide, choline hydroxide, lithium hydroxide, sodium hydroxide, or potassium hydroxide, carbonates, bicarbonates, amines and other basic materials. In some cases and some applications solvent developers well known in the industry may be used.

The currently disclosed novel laser ablation composition containing VIII, VIV and X may further contain polymers useful for their particular properties. For example, polymers with high acid values can be added as additional polymer components to aid in the development stage as well as the stripping stage, such as, styrene-co-maleic anhydride-half ester, wherein the ester group may impart certain properties to the composition.

The currently disclosed novel laser ablation composition containing component X may also contain as additional components silicon-based materials, capable of reacting with photo-generated free radicals may also be used. These materials include, for example, silsesquioxane full or partial cage materials, as well as ladder materials, which can be included to impart

improved toughness, thermal stability and other desirable properties to the composition and the final relief image. Acrylates, methacrylates, and vinyl groups may be attached to the silicon material to impart curability. An example is octa-acrylo-silsesquioxane type of materials.

Another aspect of this novel composition is where component a) group is selected from (X). where further in the component b), the conjugated aryl additive, is (II).

Another embodiment of the novel composition in any of the above described embodiment is where the conjugated aryl additive absorbs ultraviolet radiation strongly having a molar absorptivity between 220 nm and 310 nm of between 10 and 1000 m²/mol. In another embodiment of this aspect of the invention the molar absorptivity is between 100 and 1000 m²/mol. In still another embodiment it is between 200 and 1000 m²/mol.

Another embodiment of the novel composition in any of the above described embodiment is where the conjugated aryl additive has a molar absorptivity at 248 nm between 10 and 1000 m²/mol. In another embodiment of this aspect of the invention the molar absorptivity is between 100 and 1000 m²/mol. In still another embodiment it is between 200 and 1000 m²/mol.

Another embodiment of the novel composition in any of the above described embodiment is where the conjugated aryl additive has a molar absorptivity at 308 nm between 10 and 1000 m²/mol. In another embodiment of this aspect of the invention the molar absorptivity is between 100 and 1000 m²/mol. In still another embodiment it is between 200 and 1000 m²/mol.

METHODS OF FORMING IMAGES WITH BROADBAND RADIATION

The current application further discloses methods of forming negative relief images with all embodiments after exposure to broadband radiation. The compositions of the current disclosure are coated onto a chosen substrate and dried. The thus created film is then imagewise exposed through a

negative mask using broadband radiation which output contains wavelengths between (350-450nm) suitable to generate free radicals. The patterns that are exposed to the radiation cure or harden. Aqueous base developer is next applied to the film, and the areas which were not exposed to radiation are solubilized and removed from the substrate.

Coating can be accomplished by any of a number of coating methods, such as, for example, spin coating, slot coating, dip coating, curtain coating, roller coating, wire coating or other known methods. The thus applied coatings are dried of their solvent, to less than 5% solvent. Drying may be performed by hot plate heating, convection, infrared or other known methods for removing solvent from a coated film. In many thick film applications, imagewise exposure energies of less than 1000 mW at wavelengths greater than 300 nm are needed, such as 365 nm, 405 nm, 436 nm and broadband for instance between 350 and 450 nm. After exposure, an appropriate developer is applied to the film, such as 0.25N tetrabutylammonium hydroxide. The developer may be applied by spin coating, dipping, spraying or soaking, and may be room temperature or may be heated depending on the solubility of the unexposed, as well as the exposed, photoresist in the developer. Typical applications for thick film photoresists require 3/1 aspect ratio, wherein the photoresist at 30 - 60 μm (microns) thicknesses create holes and trenches which are 15 - 70 μm (microns) wide.

Using either a coated film which has been blanket exposed with broadband radiation and crosslinked, or a topographical negative image created by exposure to broadband radiation through a mask followed by aqueous base development the blanket exposed film or remaining negative film in the negative image may be further patterned by cold laser ablation employing an Excimer laser emitting between 222 nm and 308 nm.

After removing the unexposed areas, patterns has been created in the film with the surface of the substrate now capable of further processing, such as, for example, electroplating metal into the relief areas, creating metal lines, bumps, trenches and other structures. The surface which has now been exposed may be subjected to etching of materials on the substrate. After

etching, electroplating or other processing, the negative photoresist is removed or stripped, except in those cases where the negative photoresist is designed to be a permanent material such as a permanent dielectric. Both electroplating and etching processes are well known in the art. Stripping solutions are generally strongly alkaline solutions and are generally heated above 100°F. Often the photoresist is cured to well that the photoresist does not dissolve on the stripping solution, but swells and is removed as a gel.

One embodiment of this invention is a process comprising steps a), b) and c) as follows:

- a) coating the composition of claim 1 on a substrate;
- b) cross-linking the entire coating by irradiation with broadband UV exposure;
- c) forming a pattern in the cross-linked coating by cold laser ablating with a UV excimer laser emitting between 222 nm and 308 nm.

In another embodiment of this inventive process the broadband UV exposure is between 350 and 450 nm..

In another embodiment of this inventive process the broadband UV exposure is between 350 and 450 nm the excimer laser emits at 248 nm.

In another embodiment of this inventive process the excimer laser emits at 308 nm.

Another embodiment of this invention is a process comprising steps a), b) c), and d) as follows:

- a) coating the composition of claim 1 on a substrate;
- b) cross-linking part of the coating by irradiation with broadband UV exposure;
- c) developing the coating with aqueous base removing the unexposed areas of the film, thereby forming a first pattern;
- d) forming a second pattern in the first pattern by laser cold laser ablating with a UV excimer laser emitting between 222 nm and 308 nm.

In another embodiment of this process the excimer laser emits at 248 nm.

In a further embodiment of this process the excimer laser emits at 308 nm.

EXAMPLES

The following specific examples will provide detailed illustrations of the methods of producing and utilizing compositions of the present invention. These examples are not intended, however, to limit or restrict the scope of the invention in any way and should not be construed as providing conditions, parameters or values which must be utilized exclusively in order to practice the present invention.

Unless otherwise indicated all chemical were obtained from Sigma Aldrich (St. Louis, Missouri).

Polymer synthesis Example 1:

6.49 g of acrylic acid, 8.85 g of styrene, 21.62 g of hydroxypropyl methacrylate, and 24.89 g of tert-butyl methacrylate were admixed in 117.9 g of PGME solvent. The polymerization reaction proceeded with stirring in the presence of 1.64 g of AIBN at 90°C, under nitrogen for 18 hours. After cooling down to room temperature the reaction mixture was precipitated in DI water. The white polymer solid was washed and dried under vacuum at 50°C, yielding 61.0 g (98% yield) with a weight average molecular weight of 15496.

Formulation Example 1.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp, Exton, PA), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure® 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure® 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp, Tokyo 103-8233, Japan), **2.00g of 2-(4-**

methoxyphenyl)-4,6-bis(trichloromethyl)-1,3,5-triazine (MPTT) and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1 and Figure 1).

Formulation Example 2.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF, Ludwigshafen, Germany) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp), **2.00g of methoxy naphthalene (MN)** and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 3.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp), **2.00g of 1,5-dihydroxynaphthalene (DHN)** and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5

min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 4.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp), **2.00g of 9-fluorenone (9-FN)** and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C.

The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 5.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp), **2.00g of 9-anthracene methanol (9-AM)** and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick.

The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 6.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp, Exton, PA), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp, Tokyo 103-8233, Japan), **2.00g of 9-Phenanthrol (9-Ph)**, and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 7.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp, Exton, PA), and 21.21 g of DHDMA (from Sartomer Corp). After rolling overnight, 3.54 g of Irgacure[®] 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure[®] 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp, Tokyo 103-8233, Japan), **2.00g of Pyrene**, and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 8 (Reference).

36.06 g of the polyGK65 (from Dupont) was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp), and 21.21 g of 2,5-dimethyl-2,5-hexanediol dimethacrylate (DMHMA) (from ENF). After rolling overnight, 3.54 g of Irgacure® 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure® 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp), **2.00g of 2-(4-methoxyphenyl)-4,6-bis(trichloromethyl)-1,3,5-triazine (MPTT)** and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 2000 mJ/cm². The resulting film was laser ablated (Table 1).

Formulation Example 9 (Reference).

36.1 g of Cresol novolak resin (from AZ Electronic Materials) and 5.3 g Cymel 301 as crosslinker (from AZ Electronic Materials) were admixed with 56.3 g of propylene glycol monomethyl ether acetate. After rolling overnight, 1.1 g of NIT PAG (available from Heraeus- Daychem) and 0.02 g of APS437 (available from available from D.H. Litter Co) and **2.00g of 2-(4-methoxyphenyl)-4,6-bis(trichloromethyl)-1,3,5-triazine (MPTT)** were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 3 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. The resist coating was exposed at 1200 mJ/cm². The resulting film was performed laser ablation.

Comparative Formulation Example 1.

35.34 g of the polymer prepared from Example 1, above, was admixed with 21.66 g of propylene glycol monomethyl ether acetate, 14.14 g of SR268 (from Sartomer Corp, Exton, PA), and 21.21 g of DHDMA (from Sartomer

Corp). After rolling overnight, 3.54 g of Irgacure® 907 (2-Methyl-1((4-methylthio)phenyl)-2-morpholino propan-1-one available from BASF) and 1.76 g of Irgacure® 819 (Bis(2,4,6-trimethylbenzoyl)-phenyl phosphineoxide available from BASF) were admixed. 0.01 g of Megafac R08 (from Dinippon Ink and Chemical Corp, Tokyo 103-8233, Japan), and 0.25 g CGL 1198 inhibitor were admixed and the admix was rolled for 2 days. The composition was filtered and spin coated on a silicon wafer and dried on a hot plate for 5 min at 140°C. The dried coating was measured to be 50 µm (microns) thick. Different resist coatings was exposed at 300 mJ/cm² (25 % cure) or 1200 mJ/cm² (100 % cure). The resulting film was laser ablated but all coatings had no effective capacity to undergo laser ablation to form contact holes (Figure 1).

Broadband and Laser Ablation (with 308 nm) PROCESSING RESULTS:

Laser Ablation Comparisons.

The laser ablations results are summarized in Table 1. These results were obtained from coatings on silicon wafers using Formulation Examples 1-9 and Comparative Example 1. These coatings were obtained by spin coating the formulation unto the wafers at a spin speed of 1000 rpm to 2400 rpm then baking the coating at a temperature of 140°C for 5 min using a Suss ACS300 plus track giving coating having a thickness of 50 µm (microns). The coated wafer were then, "cured" with a Broadband radiation exposure (350-450 nm) using a Suss MA-200 Mask Aligner. The cured coatings prepared with Formulations Examples 1-7 and 9 were exposed to 1200 mJ/cm² (100 % cure) and Formulation Example 8 to 2000mJ/cm² (100% cure), while the coatings prepared from the Comparative Example 1 where either exposed to 1200 mJ/cm²(100% cure) or 300 mJ/cm² (25% cure). The cured wafers were ablated using a Suss Excimer Laser Stepper: model M410. Excimer lasers (XeCl, 308nm and KrF, 248nm). These Laser ablation tools are routinely used in various microfabrication, micromachining, and surface modification applications. The excimer laser is very effective in polymer ablation due to the short pulse duration and high peak power. The fluence was in the range of

200-1000mJ/cm² and frequency was 100Hz. The ablated vias were characterized by top down scanning electron microscopy (SEM). As summarized in Table 1 all coating prepared from formulations Example 1-9 gave good laser ablation which was used to produce via contact holes ranging in size from 40 to 200 μm (microns) having good wall angles of at least 78°.

Table 1: Summary of the Formulation Examples and Comparative Example

Formulation Example #	Composition Types	Additives	Ablation Results with 365nm Laser
1	X	MPTT	Ablated
2	X	MN	Ablated
3	X	DHN	Ablated
4	X	9-FN	Ablated
5	X	9-AM	Ablated
6	X	9-Ph	Ablated
7	X	Pyrene	Ablated
8 Ref.	VIV	MPTT	Ablated
9 Ref.	VII	MPTT	Ablated
Comparative #1	X	N/A	No ablation

Figure 1 shows a comparison of top down SEM pictures which illustration the attempted formation of via holes with laser ablation using a 308 nm laser in coatings prepared from formulations which either do contain, or do not contain a laser ablation additive MPTT.

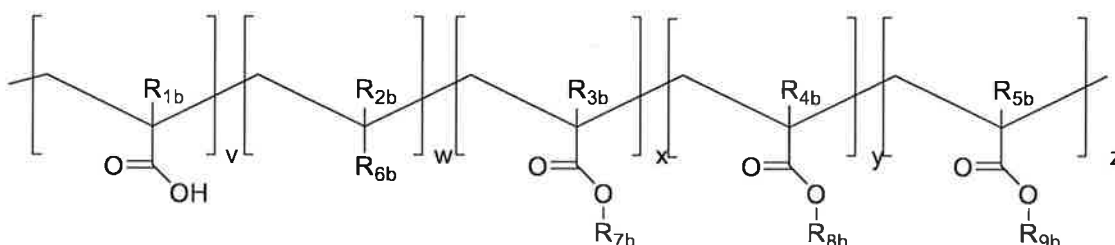
Specifically, coatings prepared with “Comparative Formulation Example 1” which does not contain the laser ablation additive MPTT give no effective ablation to form a contact hole. This is true with either a film which is UV cured at 25 % or 100 % prior to laser ablation with the 308 nm laser. In contrast Example 1 with 2 wt % of MPTT shows an ablation rate of 1.49 μm /pulse and gives via hole with a 78.1° sidewall angle was achieved.

CLAIMS

1. A composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);

a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of

a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH₃, R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C₂ - C₁₀ hydroxy alkyl group; R_{9b} is an acid cleavable group, v = 10 - 40 mole%, w = 0 - 35 mole%, x = 0 - 60 mole%, y = 10 - 60 mole% and z = 25 - 40 mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

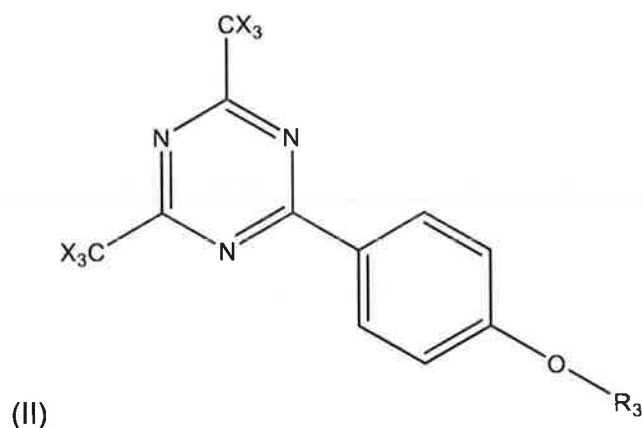
c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and

d-2) a photoresist solvent,

and

b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet

radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



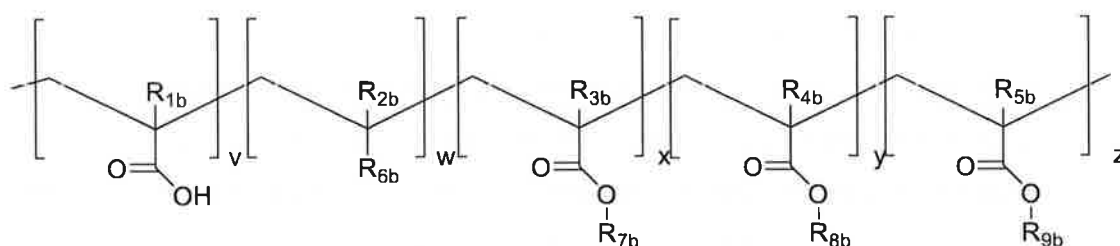
where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylene fluoroalkyl group, an alkylene aryl group, and an alkylene oxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I.

2. The composition of claim 1 where the conjugated aryl additive has between the wavelengths of 220 nm and 310 nm a molar absorptivity of between 10 and 1000 m^2/mol .
3. The composition of claim 1 where the conjugated aryl additive has a molar absorptivity at 248 nm between 10 and 1000 m^2/mol .
4. The composition of claim 1 where the conjugated aryl additive has a molar absorptivity at 308 nm between 10 and 1000 m^2/mol .
5. The composition of any of claims 1 to 4 where in the conjugated aryl additive (II), R_3 is an alkyl group, and X is Cl.
6. The composition of any of claims 1 to 5 where the photoresist solvent selected from the group consisting of C_1 - C_4 alcohols, C_4 - C_8 ethers, C_3 - C_6 ketones, C_3 - C_6 esters, and mixtures thereof.

7. The composition of any of claims 1 to 6 where the photoresist solvent is selected from ketones such as acetone, methyl ethyl ketone, cyclohexanone, methyl isoamyl ketone, methyl amyl ketone, polyhydric alcohols and derivatives thereof such as monomethyl, monoethyl, monopropyl, monobutyl and monophenyl ethers of ethyleneglycol, ethyleneglycol monoacetate, diethyleneglycol, diethyleneglycol monoacetate, propyleneglycol, propyleneglycol monoacetate, dipropyleneglycol or dipropyleneglycol monoacetate, cyclic ethers such as dioxane, tetrahydrofuran, esters such as methyl lactate, ethyl lactate, methyl acetate, ethyl acetate, butyl acetate and solvents having aromatic groups such as anisole, ethyl benzene, xylenes, chlorobenzene, toluene, solvents having one or more polar functional groups such as hydroxyl, ether, amide, ester, ketone, and carbonate, polyols such as polyethylene glycol, polypropylene glycol, poly(ethylene-co-propylene glycol), polyvinyl alcohol, trimethylol propane, ethylene glycol, glycerin, diethylene glycol, triethylene glycol, tripropylene glycol, tetraethylene glycol, pentaethylene glycol, 1,2-propylene glycol, 1,3-propanediol, butylene glycol, triethylene glycol, 1,2,6-hexanetriol, thiodiglycol, hexylene glycol, bis-2-hydroxyethyl ether, 1,4-butanediol, 1,2-butanediol, 1,4-butanediol, 1,3-butanediol, 1,5-pentanediol, 2,4-pentanediol, 2,4-heptanediol, 1,8-octanediol, 1,10-decanediol, 1,12-dodecanediol, 1,4-cyclohexanediol, 1,4-cyclohexanedimethanol, 1,2-bis(hydroxymethyl)cyclohexane, 1,2-bis(hydroxyethyl)-cyclohexane, 3-methyl-1,5-pentanediol, 2,2,4-trimethyl-1,3-pentanediol, neopentyl glycol, pentaerythritol, sorbitol, mannitol, and any combination thereof, glycol ethers such as ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, propylene glycol monomethyl ether, tripropylene glycol monomethyl ether, ethylene glycol monobutyl ether, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, propylene glycol n-propyl ether, propylene glycol t-butyl ether, propylene glycol n-butyl ether, dipropylene glycol methyl ether, dipropylene glycol n-propyl ether, dipropylene glycol t-butyl ether, dipropylene glycol n-butyl ether, tripropylene glycol n-propyl ether, tripropylene glycol t-butyl ether, tripropylene glycol n-butyl ether, ethyl cellosolve, methyl cellosolve, polyethylene glycol

monomethyl ether, polypropylene glycol monomethyl ether, methoxytriglycol, ethoxytriglycol, butoxytriglycol, 1-butoxyethoxy-2-propanol, and any combination thereof.

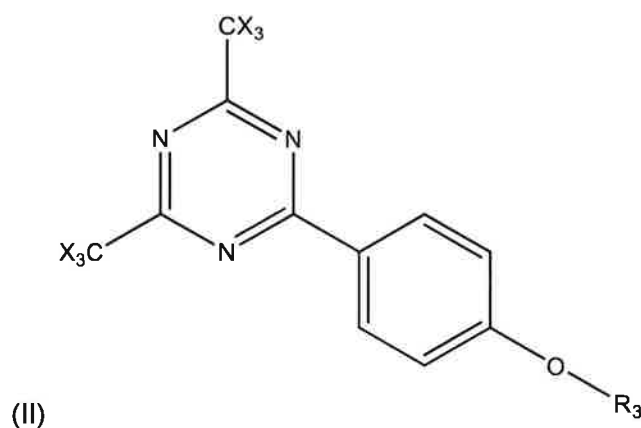
8. A process for making relief images comprising steps a), b) and c)
- a) coating a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);
- a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of
- a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C_2 - C_{10} hydroxy alkyl group and a C_2 - C_{10} hydroxy alkyl acrylate; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 0 - 45$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

- b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

- c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and
- d-2) a photoresist solvent,
- and
- b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



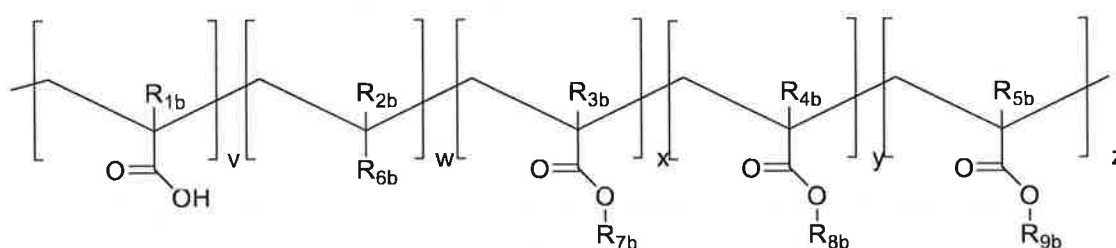
where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylene fluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I,

on a substrate;

- b) cross-linking the entire coating by blanket irradiation with broadband UV exposure; and
- c) forming a pattern in the cross-linked coating by cold laser ablating with a UV excimer laser emitting between 222 nm and 308 nm.

9. The process of claim 8 where the broadband UV exposure is between 350 and 450 nm.

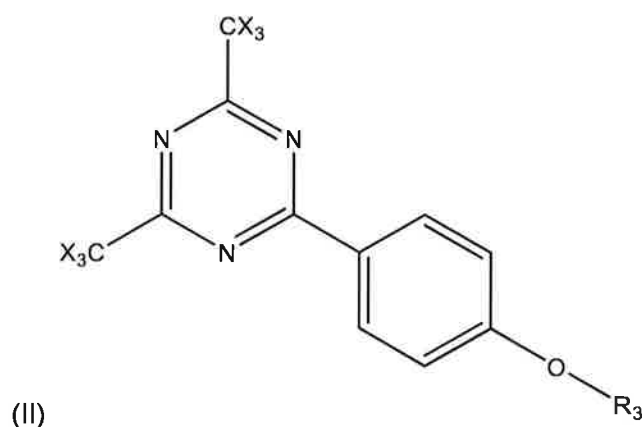
10. The process of claim 8 or 9 where the excimer laser emits at 248 nm or 308 nm.
11. The process of any of claims 8 to 10 where the coating has a thickness of 30 to 60 μm .
12. A process for making relief images comprising steps a), b), c) and d)
a) coating a coating a composition for a negative tone, aqueous base developable, broadband UV resist which is also sensitive in the areas exposed to broadband irradiation to subsequent cold laser ablation by an UV Excimer Laser emitting between 222 nm and 308 nm where the composition is comprised of components of type a) and b);
a) components for imparting negative tone, aqueous base developable, broadband UV resist behavior comprised of
a-2) at least one polymer comprising a structure of the following formula:



wherein each of R_{1b} - R_{5b} is independently selected from the group consisting of H, F and CH_3 , R_{6b} is selected from the group consisting of a substituted aryl, unsubstituted aryl, substituted heteroaryl and unsubstituted heteroaryl group; R_{7b} is a substituted or unsubstituted benzyl group; R_{8b} is selected from the group consisting of a linear or branched C_2 - C_{10} hydroxy alkyl group and a C_2 - C_{10} hydroxy alkyl acrylate; R_{9b} is an acid cleavable group, $v = 10 - 40$ mole%, $w = 0 - 35$ mole%, $x = 0 - 60$ mole%, $y = 10 - 60$ mole% and $z = 0 - 45$ mole% as a resin containing phenolic moieties, carboxylic acid moieties or a combination of both types moieties such that the resin dissolves in aqueous base;

- b-2) one or more free radical initiators activated by actinic radiation as photo-initiator sensitive to broadband irradiation,

- c-2) one or more crosslinkable acrylated monomers capable of undergoing free radical crosslinking wherein the acrylate functionality is greater than 1 as cross-linker, and
- d-2) a photoresist solvent, and
- b) a cold laser ablation excimer laser sensitizer component system comprised of at least one conjugated aryl additive absorbing ultraviolet radiation strongly in a range between from 222 nm to 310 nm, selected from the group consisting of (II);



where each R_3 is independently selected from the group consisting of hydrogen, an alkyl group, an alkylene fluoroalkyl group, an alkylene aryl group, and an alkyleneoxyalkyl group; X_3 is selected from the group consisting of Cl, Br or I,

on a substrate;

- b) cross-linking part of the coating by irradiation with broadband UV exposure through a mask;
- c) developing the coating with aqueous base removing the unexposed areas of the coating, thereby forming a first pattern;
- d) forming a second pattern in the first pattern by cold laser ablating of the first pattern with a UV excimer laser emitting between 222 nm and 308 nm.

13. The process of claim 12 where the excimer laser emits at 248 nm or 308 nm.